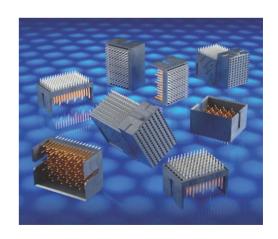
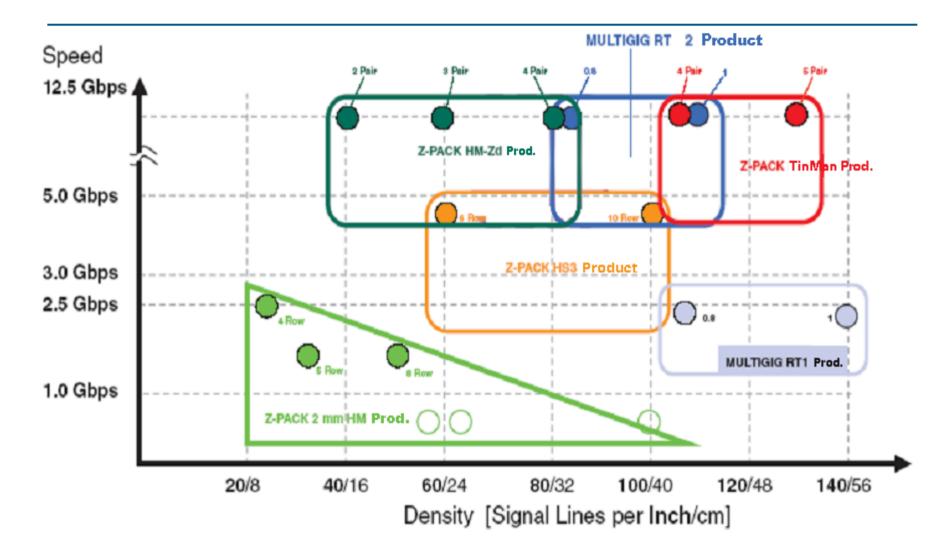
### **Z-PACK TinMan Connector System**

MULTIGIG RT, TE logo, Tyco Electronics, Z-PACK and Z-PACK TinMan are trademarks. Other products, logos, and company names herein may be trademarks of their respective owners.





### Backplane Connectors Roadmap

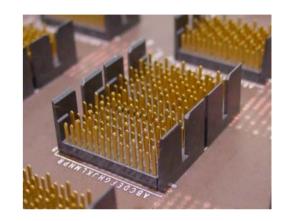


### Z-PACK TinMan Connector System

- Exceptional differential performance, 10+ Gb/s
- High density
- Low cost
- Bellcore/Telcordia compliant
- Repairable pins on backplane
- Fully compliant with all "HM" compliant guide and power modules







Telcordia is a trademark of Telcordia Technologies, Inc.



# Z-PACK TinMan Connector System Connector Configurations

- Traditional backplane configuration
  - Vertical header to R/A receptacle





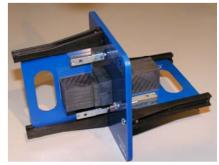
- Co-planar applications
  - R/A header to R/A receptacle



- Mezzanine applications
  - Vertical header to vertical receptacle





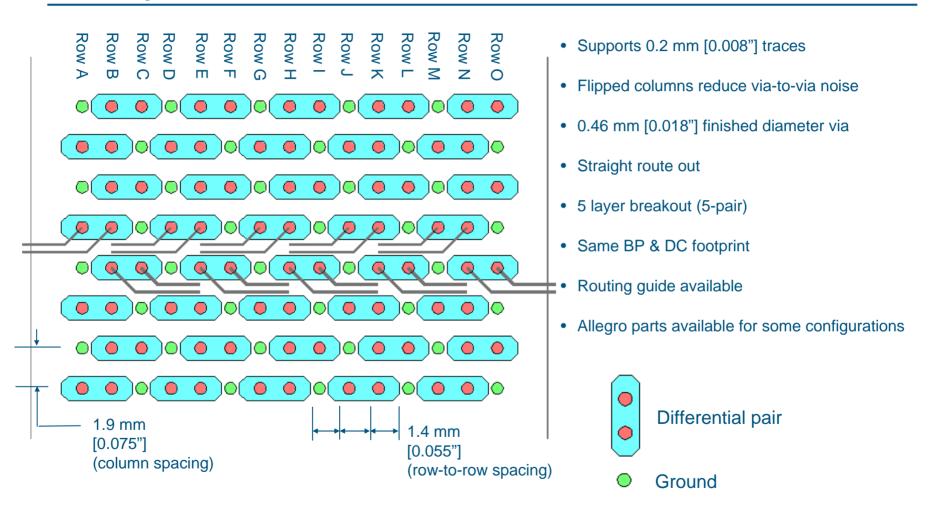


### Z-PACK TinMan Connector System Density Options

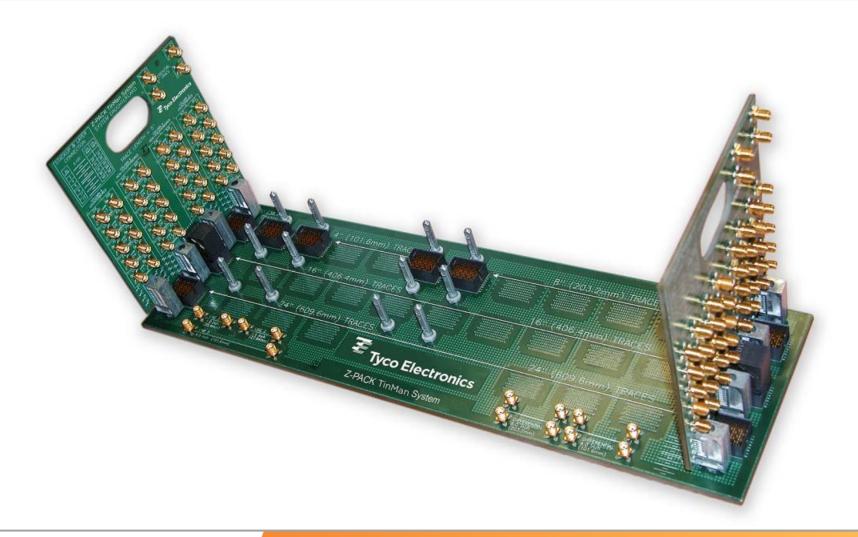
Pairs per Column	Part Envelope mm [in]	Density Pairs/cm [Pairs/in]	Column Pitch mm [in]
3 Pair	16.0 mm [0.630"]	15 /cm [40 /in]	1.9 mm [0.075"]
4 Pair	20.2 mm [0.795"]	21 /cm [53 /in]	1.9 mm [0.075"]
5 Pair	24.4 mm [0.961"]	26 /cm [66 /in]	1.9 mm [0.075"]

- Parts available with and without end walls
- All parts 10+ Gbps capable

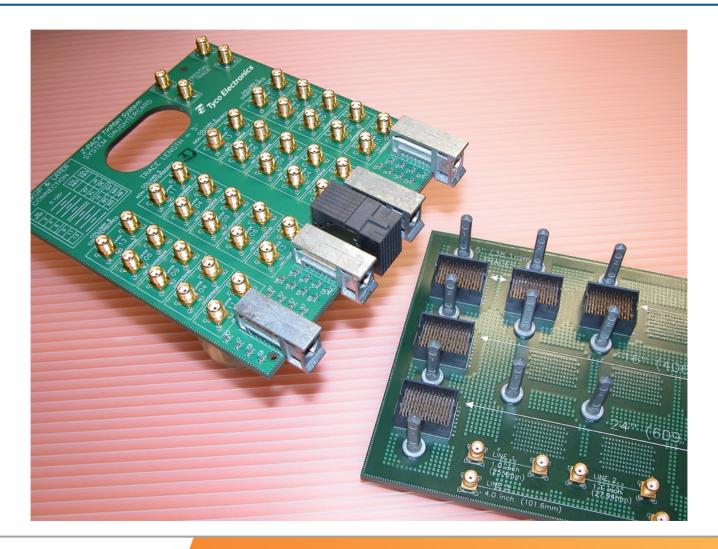
# Z-PACK TinMan Connector System Footprint Via Pattern



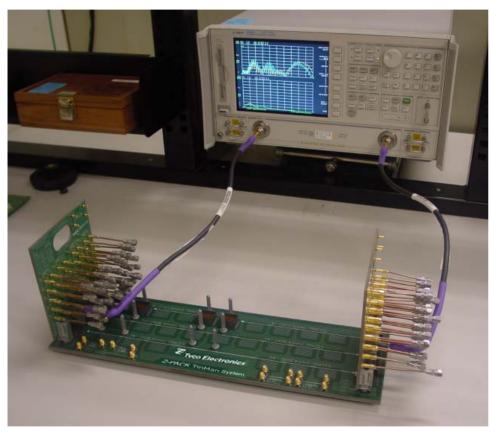
# Z-PACK TinMan Connector System System Evaluation Kit



### Z-PACK TinMan Connector System System Evaluation Kit



# Z-PACK TinMan Connector System System Evaluation Kit

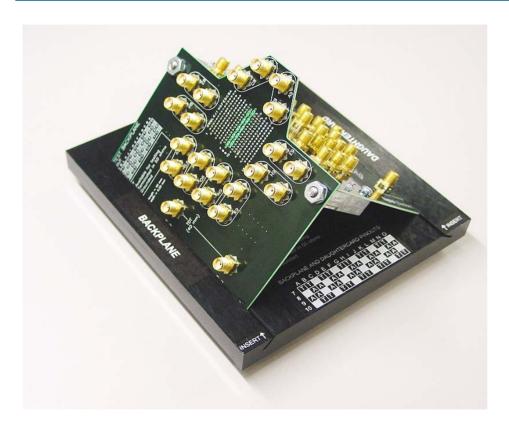


- Provides data showing the connector's performance in a typical system environment
- 2 Daughtercards
  - -3.18 mm [0.125"] thickness
  - Nelco 4000-6 material
  - -127 mm [5.0"] trace length
  - -0.13 mm [0.005"] trace width
- Backplane
  - -5.08 mm [0.200"] thickness
  - Nelco 4000-13 material
  - Various trace lengths
  - -0.18 mm [0.007"] trace width
- Links with and without counterboring
- Available for loan

Nelco is a trademark of New England Laminates Company, Inc.



### Z-PACK TinMan Connector System Connector-Only Evaluation Kit



- Same test boards used for all tests
- Provide "connector only" data (minimal footprint)
- 1.5 mm [0.060"] board thickness
- Bottom layer via connect
- Short traces (40 mm [1.575"])
- Available for loan
- Following data tested using
  - TDS8000 Digital SamplingOscilloscope
  - Agilent E8364B PNA Analyzer

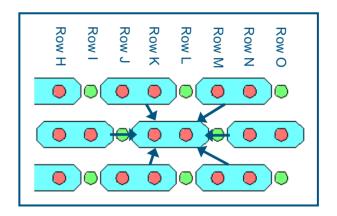
TDS8000 is a trademark of Tektronix, Inc.

Agilent is a trademark of Agilent Technologies, Inc.



# Z-PACK TinMan Connector System Worst-case NEXT/FEXT, Worst-case Pinout

Pair	NEXT	FEXT
AB9	1.1%	0.5%
BC8	2.5%	1.0%
DE9	2.9%	1.1%
EF8	2.7%	1.1%
GH9	2.7%	1.1%
HI8	2.8%	1.2%
JK9	2.7%	1.0%
KL8	2.6%	1.1%
MN9	2.1%	0.9%
NO8	0.9%	0.5%

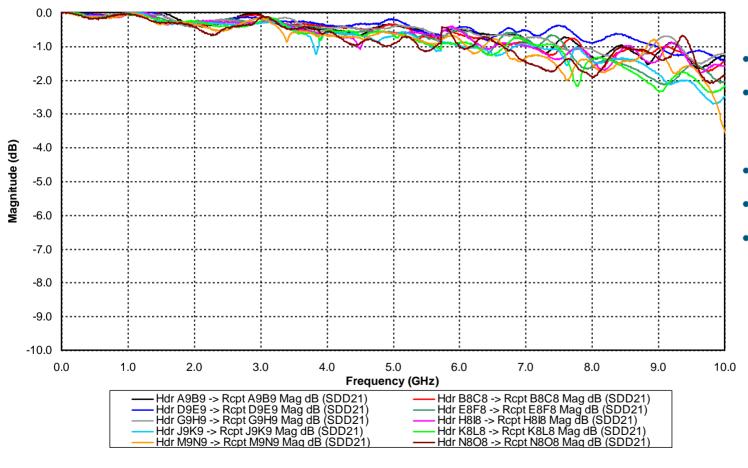


- TEST DATA
- Single mated 5-pair
   1.9 mm column pitch connector
- Vertical header
- R/A receptacle
- 50 ps (20-80%) edge rate
- Vertical header driven far end crosstalk

- Includes two 1.5 mm [0.060"] vias to bottom layer traces
- Asynchronous sum of peaks from each aggressor
- Percentage is total noise divided by differential swing (A-B)

### Z-PACK TinMan Connector System Differential Insertion Loss

#### Z-PACK TinMan 5pr 1.9mm VHdrR1-RARcptR4



- TEST DATA
- Single mated 5-pair
   1.9 mm column pitch connector
- Vertical header
- R/A receptacle
- Includes two 1.5 mm [0.060"] vias to bottom layer traces

#### **THANK YOU**

